ASMT-QTC0-0xxxx

PLCC-4 Black Body Surface Mount Tricolor LED

Data Sheet

Lead (Pb) Free
RoHS 6 fully
compliant



Description

This family of SMT LEDs is packaged in the industry standard PLCC-4 package with additional heat sinking capability enabling it to be driven at even higher current. These SMT LEDs have high brightness and reliability performance and are designed to work under a wide range of environmental conditions. This high reliability feature makes them ideally suited to be used under indoor full color signs application conditions.

To facilitate easy pick & place assembly, the LEDs are packed in EIA-compliant tape and reel. Every reel will be shipped in single intensity and color bin; except red color to provide close uniformity.

These LEDs are compatible with reflow soldering process.

Its wide viewing angle at 115° together with the built in reflector pushing up the intensity of the light output makes these LED suitable to be used in the interior electronics signs. The full black body of the LED provides extreme contrast enhancement for fine pitch and short viewing distance full color display.

Features

- Industry Standard PLCC-4 package (Plastic Leaded Chip Carrier) with additional heat sinking capability
- High reliability LED package with silicone encapsulation
- Full black LED body
- High brightness using AlInGaP and InGaN dice technologies
- Wide viewing angle at 115°
- Compatible with reflow soldering process
- JEDEC MSL 2a
- Water-Resistant (IPX6*) per IEC 60529:2001

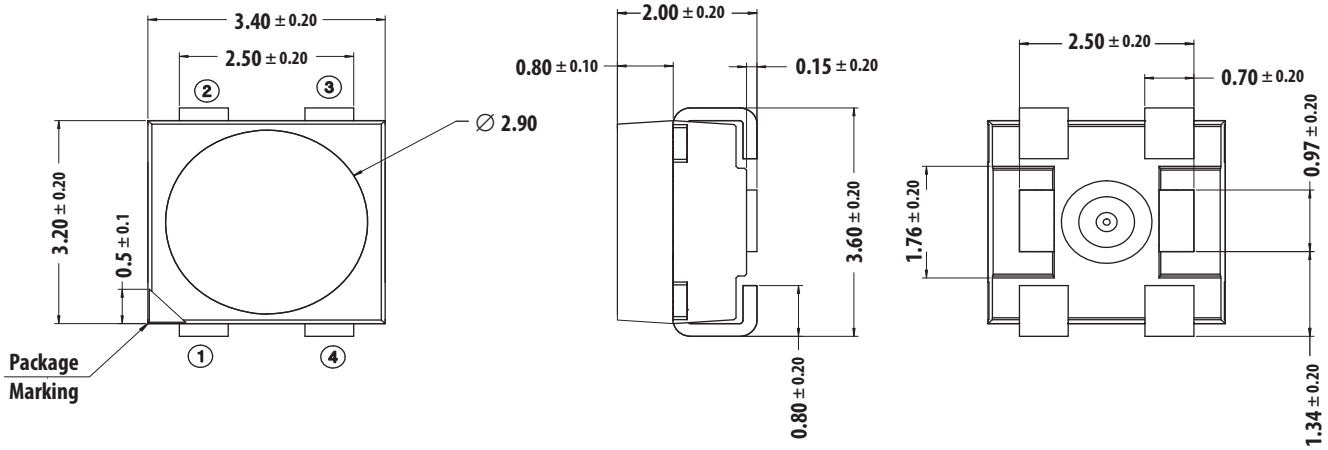
* The test is conducted on component level by mounting the components on PCB with proper potting to protect the leads. It is strongly recommended that customers perform necessary tests on the components for their final application.

Applications

- Indoor full color display

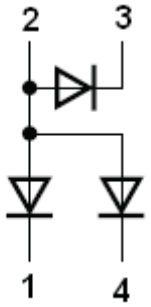
CAUTION: *LEDs are Class 1C ESD sensitive. Please observe appropriate precautions during handling and processing. Please refer to Avago Application Note AN-1142 for additional details.*

Package Dimensions



Notes:
1. All Dimensions are in millimeters
2. Tolerance = ±0.2 mm unless otherwise specified
3. Terminal Finish: Ag plating

Lead Configuration		
1	Cathode	Red
2	Common Anode	
3	Cathode	Blue
4	Cathode	Green



Circuit Diagram

Figure 1. Package drawing

Table 1. Device Selection Guide

Part Number	Color 1	Color 2	Color 3
ASMT-QTC0-0xxxx	AlInGaP Red	InGaN Green	InGaN Blue

	Color 1 - Red			Color 2 - Green			Color 3 - Blue		
	Min. Iv @20mA		Typ. Iv @20mA	Min. Iv @ 20mA		Typ. Iv @ 20mA	Min. Iv @ 20mA		Typ. Iv @ 20mA
Part Number	Bin ID	(mcd)	(mcd)	Bin ID	(mcd)	(mcd)	Bin ID	(mcd)	(mcd)
ASMT-QTC0-0AA02	S1	180	315	T1	285	470	R1	112.50	140

Notes:
1. The luminous intensity IV, is measured at the mechanical axis of the LED package. The actual peak of the spatial radiation pattern may not be aligned with this axis.
2. Tolerance = ± 12 %

Part Numbering System

A S M T –Q T C0– X_1 X_2 X_3 X_4 X_5

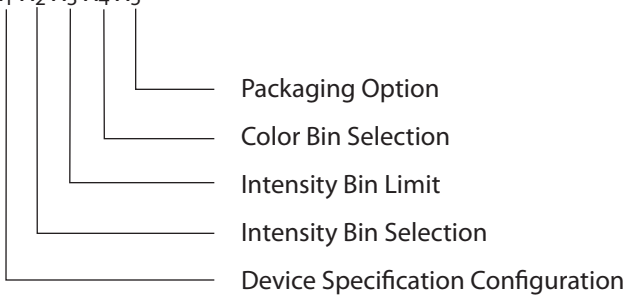


Table 2. Absolute Maximum Ratings (T_A = 25°C)

Parameter	Red	Green & Blue	Unit
DC forward current [1]	50	30	mA
Peak forward current [2]	100	100	mA
Power dissipation	120	117	mW
Reverse voltage	4V[3]		V
Maximum junction temperature Tj max	125		°C
Operating temperature range	- 40 to + 110[4]		°C
Storage temperature range	- 40 to + 110		°C

Note:
1. Derate linearly as shown in Figure 5a & 5b.
2 Duty Factor = 0.5%, Frequency = 500Hz
3. Driving the LED in reverse bias condition is suitable for short term only
4 Refer to Figure 5a and figure 5b for more information

Table 3. Optical Characteristics (T_A = 25°C)

	Dominant Wavelength, λ_d (nm) [1]			Peak Wavelength, λ_p (nm)	Viewing Angle $2\theta_{1/2}$[2] (Degrees)	Luminous Efficacy η_V[3] (lm/W)	Luminous Efficiency η_e (lm/W)	Total Flux / Luminous Intensity [4] Φ_V / I_V (lm/cd)
Color	Min	Typ.	Max	Typ.	Typ.	Typ.	Typ.	Typ.
Red	618	621	628	629	115	200	22	2.60
Green	525	528	535	521	115	530	22	2.60
Blue	465	470	475	465	115	70	5	2.60

Notes:
1. The dominant wavelength is derived from the CIE Chromaticity Diagram and represents the perceived color of the device.
2. $\theta_{1/2}$ is the off axis angle where the luminous intensity is $_{1/2}$ the peak intensity
3. Radiant intensity, Ie in watts / steradian, may be calculated from the equation Ie = I_V / η_V, where I_V is the luminous intensity in candelas and η_V is the luminous efficacy in lumens / watt.
4. Φ_V is the total luminous flux output as measured with an integrating sphere at mono pulse condition.

Table 4. Electrical Characteristics (T_A = 25°C)

	Forward Voltage, V_F (V) [1]			Reverse Voltage V_R @ 100µA	Reverse Voltage V_R @ 10µA	Thermal Resistance $R\theta_{J-P}$ (°C/W)
Color	**Min**	**Typ.**	**Max.**	**Min.**	**Min.**	**Typ.**
Red	1.80	2.10	2.40	4	-	95
Green	2.80	3.20	3.90	-	4	70
Blue	2.80	3.20	3.90	-	4	60

Note:
1. Tolerance ± 0.1V

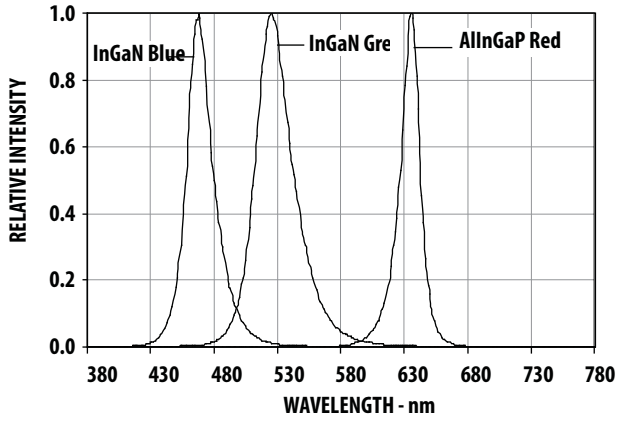


Figure 2. Relative intensity vs. wavelength

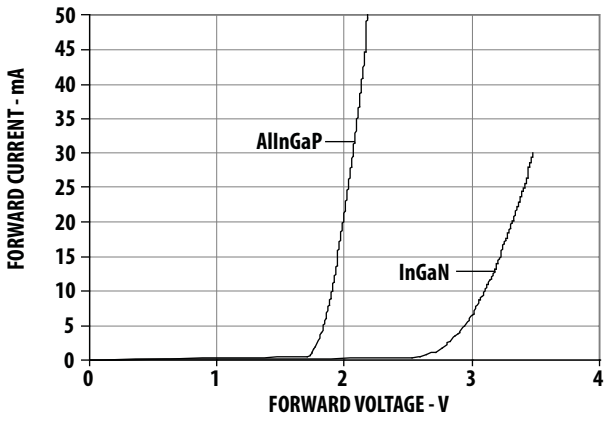


Figure 3. Forward current vs. forward voltage

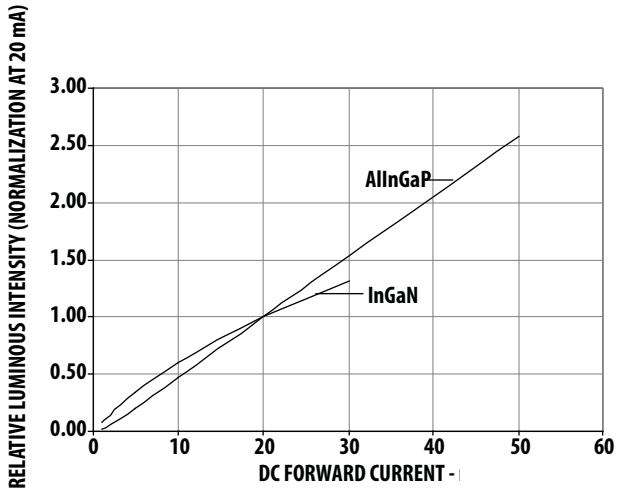


Figure 4. Relative Intensity vs. forward current

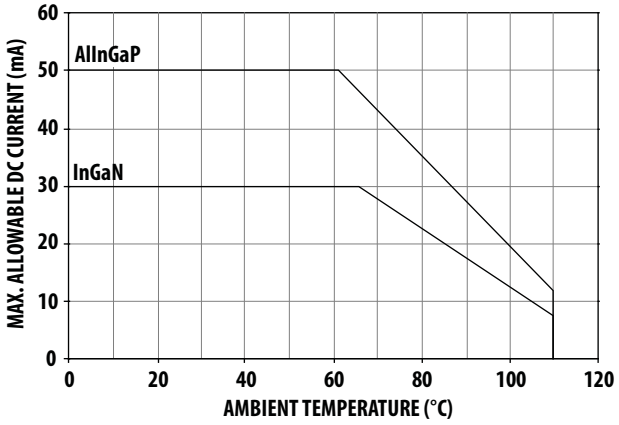


Figure 5a. Maximum forward current vs. ambient temperature. Derated based on $T_JMAX = 125°C$.(3 chips)

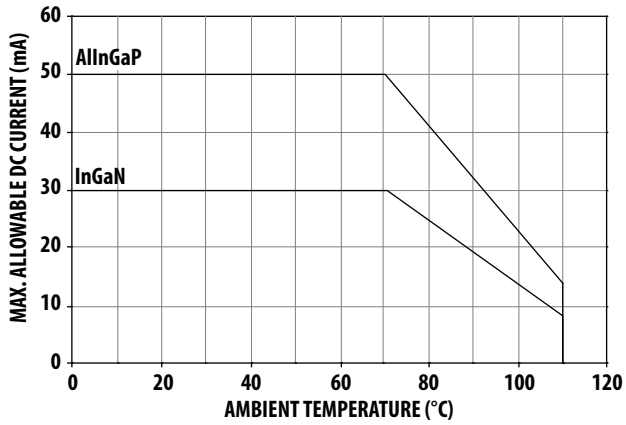


Figure 5b. Maximum forward current vs. ambient temperature. Derated based on $T_JMAX = 125°C$. (single chip)

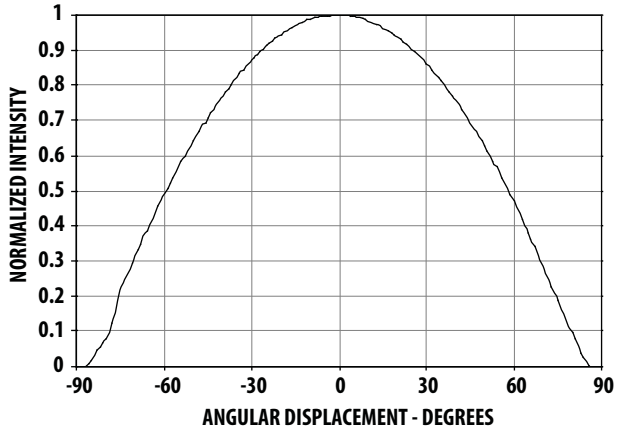


Figure 6. Radiation pattern.

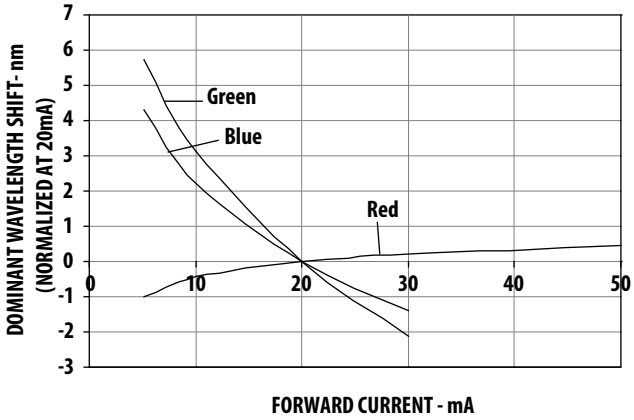


Figure 7. Dominant wavelength shift (normalized at 20mA) vs. forward current

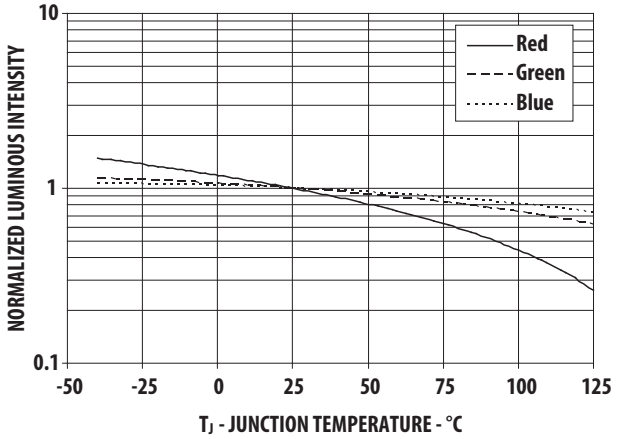


Figure 8. Relative Intensity Shift vs Junction Temperature

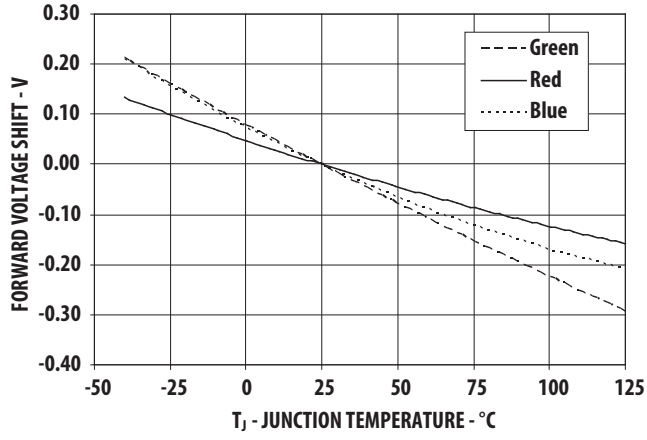


Figure 9. Forward Voltage Shift vs Junction Temperature

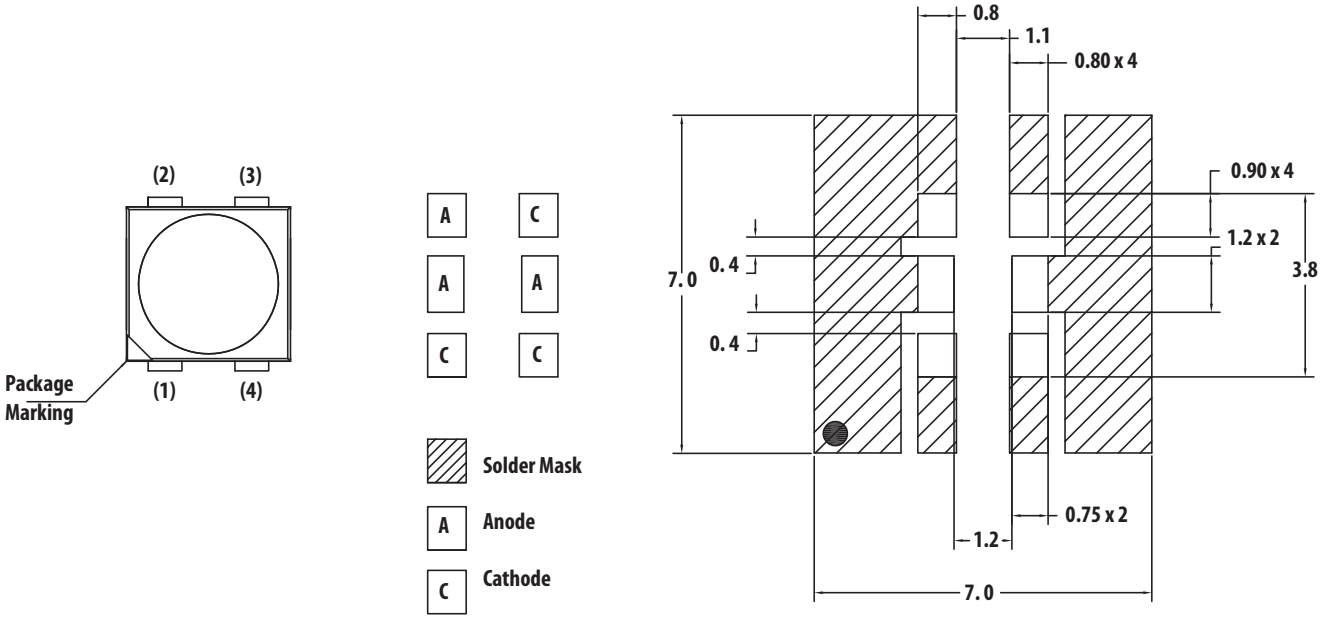


Figure 10. Recommended soldering land pattern.

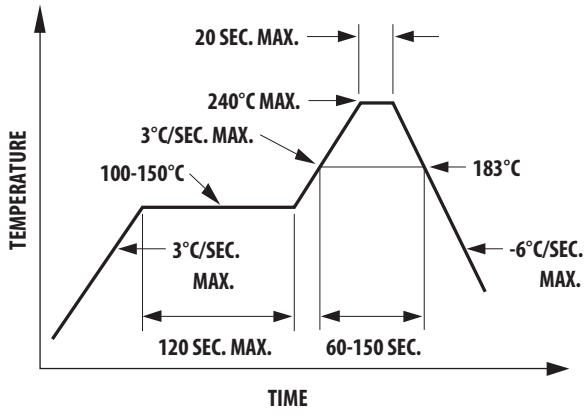


Figure 11. Recommended leaded reflow soldering profile

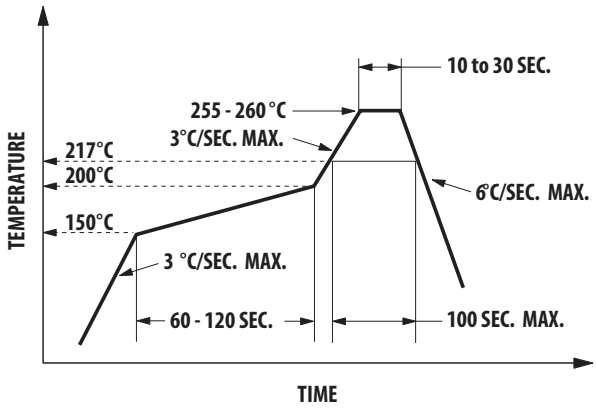


Figure 12. Recommended Pb-free reflow soldering profile.

Note: For detail information on reflow soldering of Avago surface mount LEDs, do refer to Avago Application Note AN 1060 Surface Mounting SMT LED Indicator Components

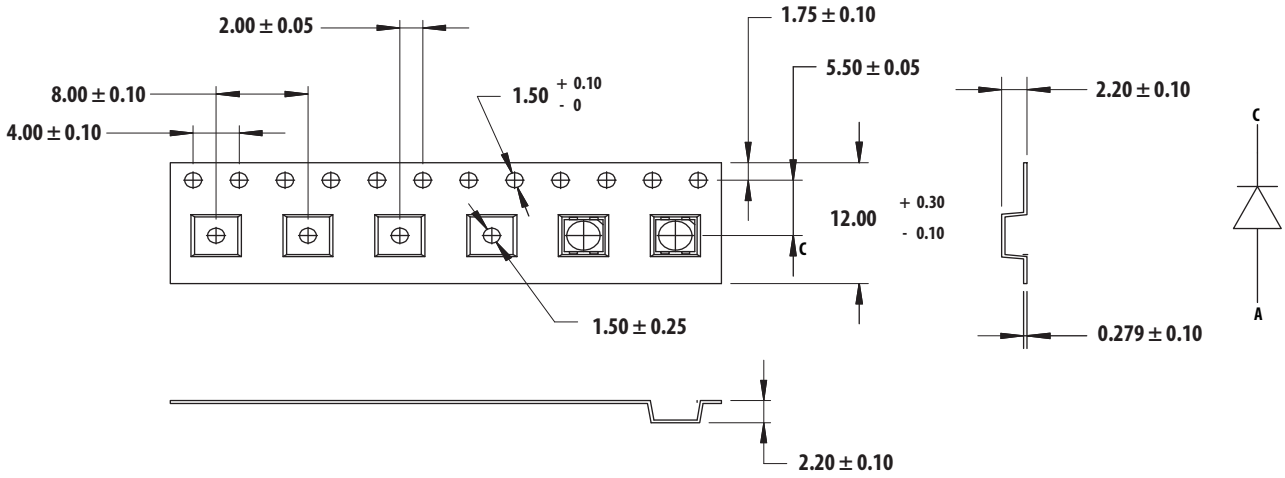


Figure 13. Carrier Tape Dimension

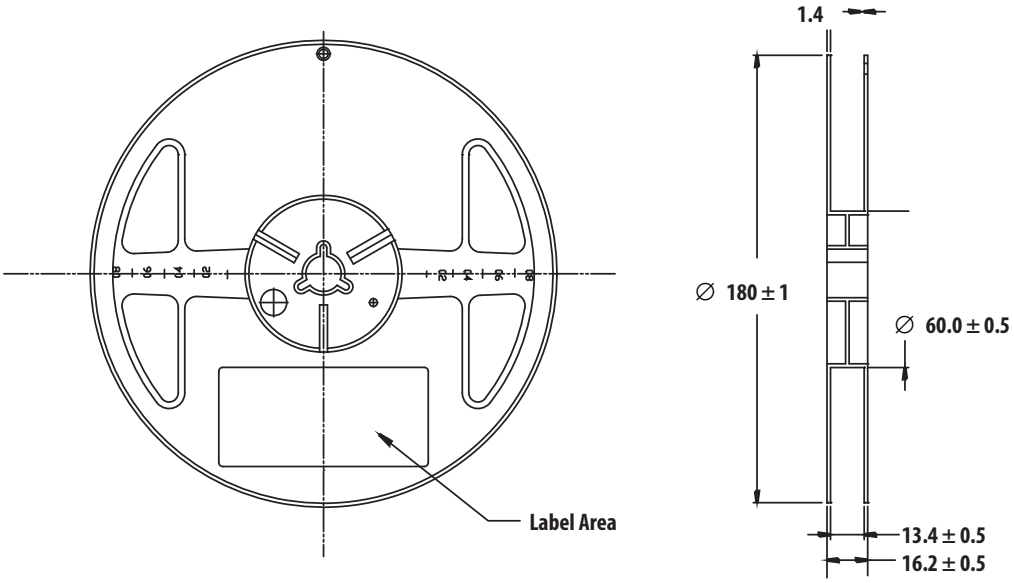


Figure 14. Reel Dimension

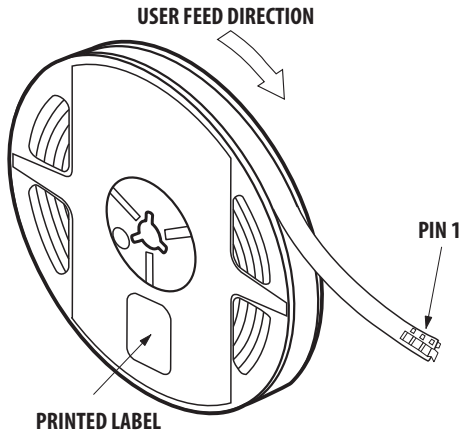


Figure 15. Reeling Orientation

Intensity Bin Select (X_2, X_3)

Individual reel will contain parts from 1 half bin only

	Min Iv Bin (Minimum Intensity Bin)		
X_2	Red	Green	Blue
0	0	0	0
A	SI	T1	R1

	Number of Half bin from X_2		
X_3	Red	Green	Blue
0	0	0	0
A	4	4	4

Note: 0 represents no maximum bin limit

Color Bin Select (X_4)

Individual Reel will contain part from 1 full bin only

	Color Bin Combinations		
X_4	Red	Green	Blue
0	Full distribution	C & D	B & C

Intensity Bin Limits

Bin ID	Min (mcd)	Max (mcd)
R1	112.5	140.0
R2	140.0	180.0
S1	180.0	224.0
S2	224.0	285.0
T1	285.0	355.0
T2	355.0	450.0
U1	450.0	560.0
U2	560.0	715.0

Tolerance of each bin limit ± 12%

Color Bin Limits

Red	Min (nm)	Max (nm)
Full distribution	618.0	628.0

Green	Min (nm)	Max (nm)
C	525.0	530.0
D	530.0	535.0

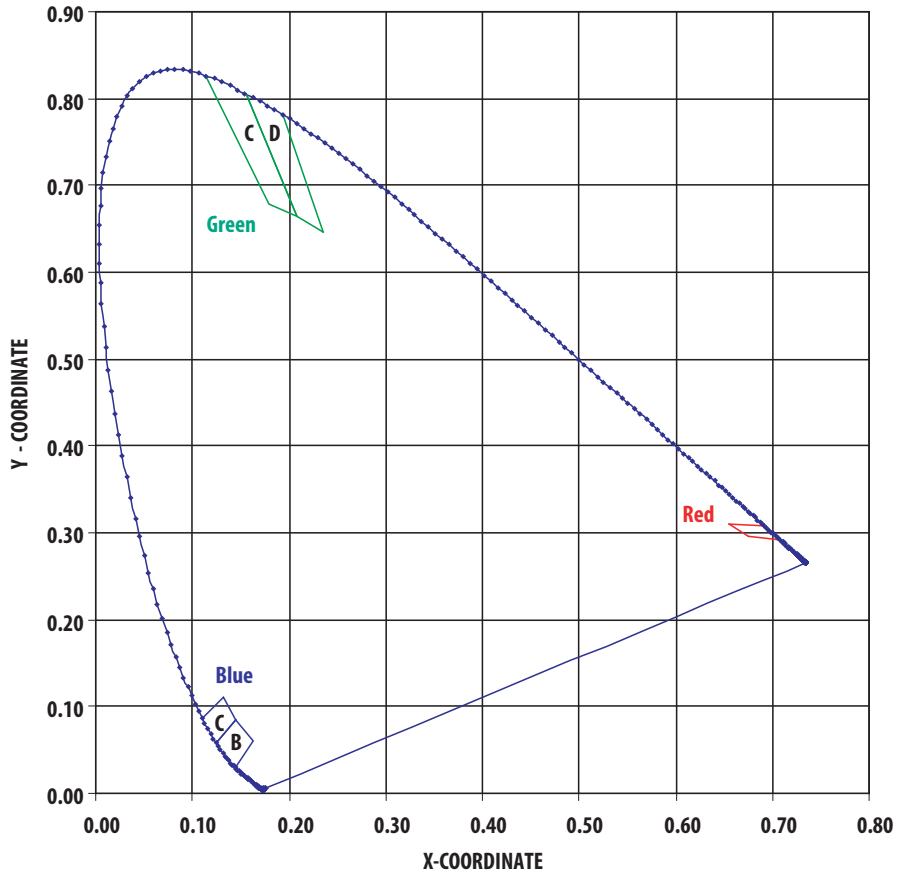
Blue	Min (nm)	Max (nm)
B	465.0	470.0
C	470.0	475.0

Tolerance of each bin limit is ± 1 nm

Packaging Option (X_5)

Option	Test Current	Package Type	Reel Size
2	20mA	Top mount	7 inch

CIE 1931 - Chromaticity Diagram



Handling Precaution

The encapsulation material of the product is made of silicone for better reliability of the product. As silicone is a soft material, please do not press on the silicone or poke a sharp object onto the silicone. These might damage the product and cause premature failure. During assembly of handling, the unit should be held on the body only. Please refer to Avago Application Note AN 5288 for detail information.

Moisture Sensitivity

This product is qualified as Moisture Sensitive Level 2a per Jedec J-STD-020. Precautions when handling this moisture sensitive product is important to ensure the reliability of the product. Do refer to Avago Application Note AN5305 Handling of Moisture Sensitive Surface Mount Devices for details.

A. Storage before use

- Unopen moisture barrier bag (MBB) can be stored at <40°C/90%RH for 12 months. If the actual shelf life has exceeded 12 months and the HIC indicates that baking is not required, then it is safe to reflow the LEDs per the original MSL rating.
- It is not recommended to open the MBB prior to assembly (e.g. for IQC).

B. Control after opening the MBB

- The humidity indicator card (HIC) shall be read immediately upon opening of MBB.
- The LEDs must be kept at <30°C / 60%RH at all time and all high temperature related process including soldering, curing or rework need to be completed within 672 hours.

C. Control for unfinished reel

- For any unuse LEDs, they need to be stored in sealed MBB with desiccant or desiccator at <5%RH.

D. Control of assembled boards

- If the PCB soldered with the LEDs is to be subjected to other high temperature processes, the PCB need to be stored in sealed MBB with desiccant or desiccator at <5%RH to ensure no LEDs have exceeded their floor life of 672 hours

E. Baking is required if:

- The HIC indicator is not GREEN at 10% and is AZURE at 5%
- The LEDs are exposed to condition of >30°C / 60% RH at any time.
- The Led floor life exceeded 672hrs.

Recommended baking condition: 60±5°C for 20hrs

For product information and a complete list of distributors, please go to our web site: **www.avagotech.com**

Avago, Avago Technologies, and the A logo are trademarks of Avago Technologies in the United States and other countries.
Data subject to change. Copyright © 2005-2010 Avago Technologies. All rights reserved.
AV02 -1038EN - April 15, 2010